

# PS7200A-1A

# 4-PIN SOP, 3.0 pF LOW OUTPUT CAPACITANCE 1-ch Optical Coupled MOS FET -NEPOC Series-

### **DESCRIPTION**

The PS7200A-1A is a low output capacitance solid state relay containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

It is suitable for high-frequency signal control, due to its low  $C \times R$ , low output capacitance, and low off-state leakage current.

### **FEATURES**

- Low C × R (C × R = 30 pF Ω)
- Low output capacitance (Cout = 3.0 pF TYP.)
- Low off-state leakage current (ILoff = 0.1 nA TYP.)
- High-speed turn-on time (ton = 0.01 ms TYP.)
- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- · Low offset voltage
- Ordering number of taping product: PS7200A-1A-E3, E4: 900 pcs/reel

: PS7200A-1A-F3, F4: 3 500 pcs/reel

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- · Pb-Free product
- Safety standards
  - UL approved: File No. E72422
  - BSI approved: No. 8241/8242
  - CSA approved: No. CA 101391

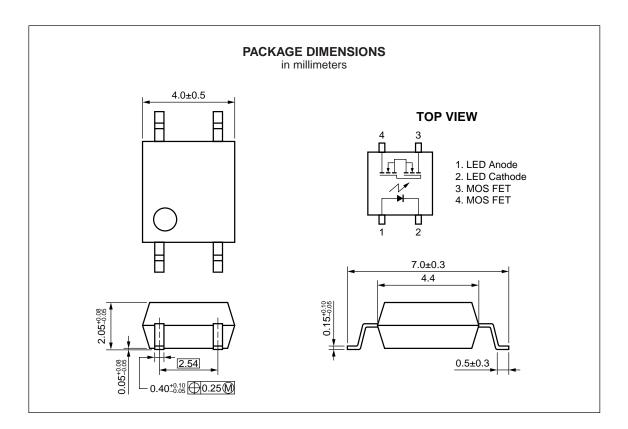
### **APPLICATIONS**

• Measurement equipment

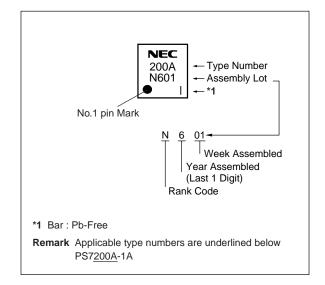
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## <R> MARKING EXAMPLE (LASER MARKING)



### <R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>*1</sup>
PS7200A-1A	PS7200A-1A-A	Pb-Free	Magazine case 100 pcs	Standard products	PS7200A-1A
PS7200A-1A-E3	PS7200A-1A-E3-A		Embossed Tape 900 pcs/reel	(UL, BSI, CSA	
PS7200A-1A-E4	PS7200A-1A-E4-A			approved)	
PS7200A-1A-F3	PS7200A-1A-F3-A		Embossed Tape 3 500 pcs/reel		
PS7200A-1A-F4	PS7200A-1A-F4-A				

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	e Forward Current (DC)		50	mA	
	Reverse Voltage	VR	5.0	V	
	Power Dissipation	Po	50	mW	
	Peak Forward Current *1	IFP	1	Α	
MOS FET	Break Down Voltage	VL	40	V	
	Continuous Load Current	lι	100	mA	
	Pulse Load Current*2 (AC/DC Connection)	ILP	200	mA	
	Power Dissipation	Po	100	mW	
Isolation Voltage*3		BV	1 500	Vr.m.s.	
Total Power Dissipation		Рт	150	mW	
Operating Ambient Temperature		TA	-40 to +85	°C	
Storage Temperature		T <sub>stg</sub>	-40 to +100	°C	

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1%

<sup>\*2</sup> PW = 100 ms, 1 shot

<sup>\*3</sup> AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

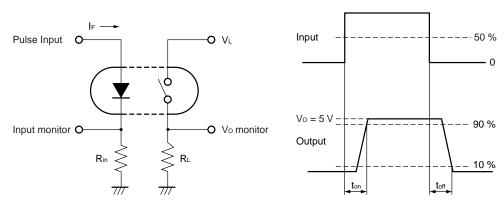
## RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

## ELECTRICAL CHARACTERISTICS (TA = 25°C)

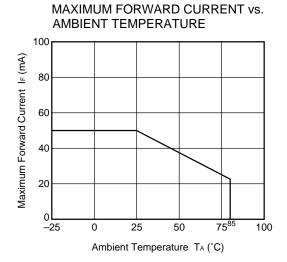
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	lR	V <sub>R</sub> = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 40 V		0.1	100	nA
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		3.0		pF
Coupled	LED On-state Current	IFon	IL = 100 mA			2.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		9.3	12	Ω
		Ron2	$I_F = 10 \text{ mA}, I_L = 100 \text{ mA}, t \le 10 \text{ ms}$				
	Turn-on Time*1,2	ton	If = 10 mA, Vo = 5 V, $R_L$ = 500 $\Omega$ ,		0.01	0.5	ms
	Turn-off Time*1,2	toff	PW ≥ 10 ms		0.07	0.2	
	Isolation Resistance	R <sub>I-O</sub>	Vi-o = 1.0 kVpc	10 <sup>9</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		0.5		pF

## \*1 Test Circuit for Switching Time

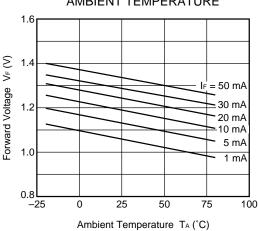


<R> \*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

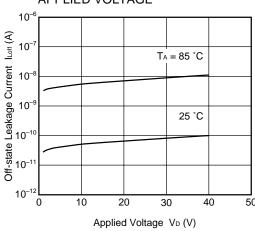
### TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)





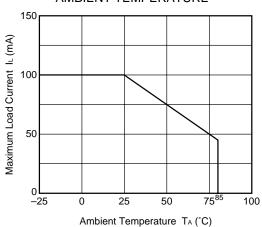


OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE

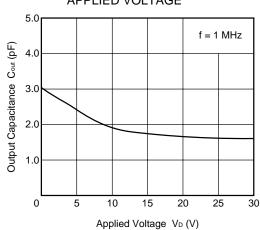


Remark The graphs indicate nominal characteristics.

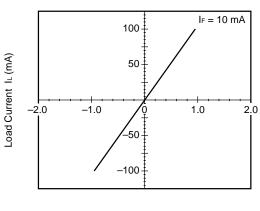




## OUTPUT CAPACITANCE vs. APPLIED VOLTAGE

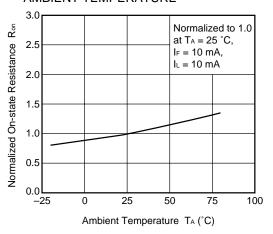


## LOAD CURRENT vs. LOAD VOLTAGE

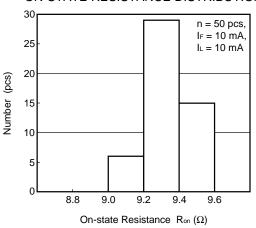


Load Voltage V<sub>L</sub> (V)

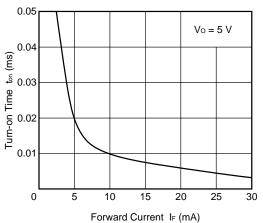
## NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



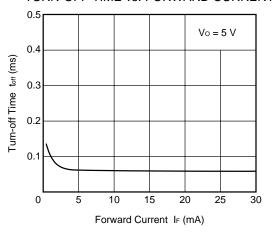
## ON-STATE RESISTANCE DISTRIBUTION



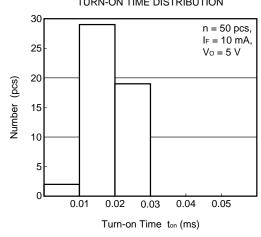
### TURN-ON TIME vs. FORWARD CURRENT



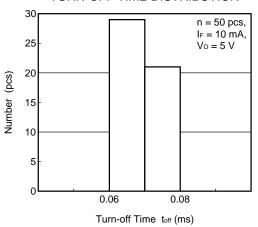
TURN-OFF TIME vs. FORWARD CURRENT



## TURN-ON TIME DISTRIBUTION

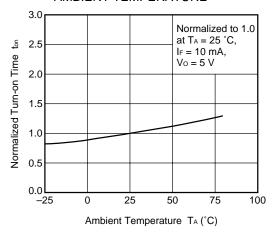


TURN-OFF TIME DISTRIBUTION



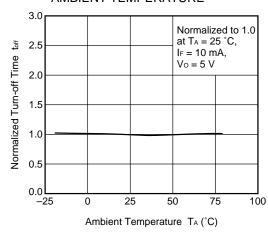
Remark The graphs indicate nominal characteristics.

## NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

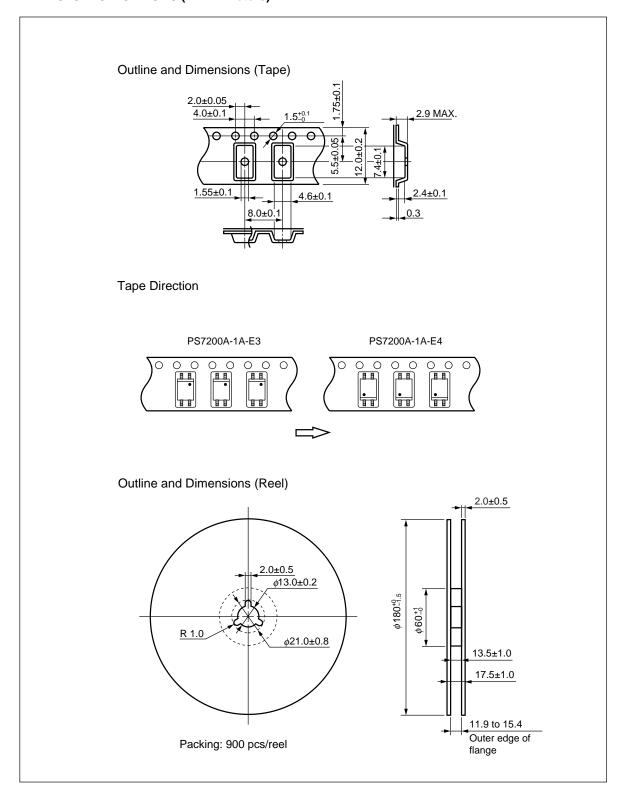


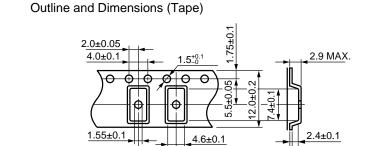
**Remark** The graphs indicate nominal characteristics.

## NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE

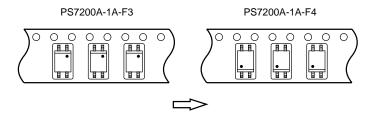


## **TAPING SPECIFICATIONS (in millimeters)**

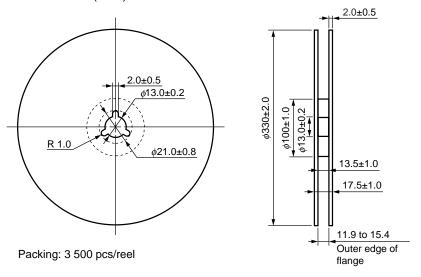




Tape Direction



## Outline and Dimensions (Reel)



### RECOMMENDED SOLDERING CONDITIONS

### (1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

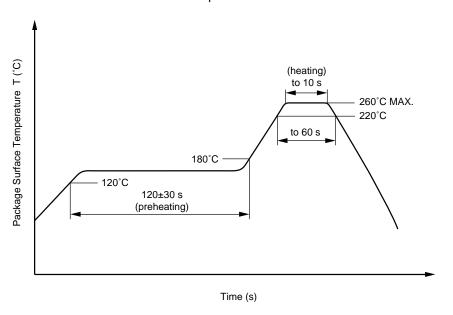
Time of peak reflow temperature
 Time of temperature higher than 220°C
 10 seconds or less
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



## (2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

## <R> (3) Soldering by soldering iron

Peak temperature (lead part temperature)
 Time (each pins)
 350°C or below
 3 seconds or less

Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

**10** Data Sheet PN10291EJ02V0DS

## <R> USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

### Caution

**GaAs Products** 

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

### ▶ For further information, please contact

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